



MATERIALS AND FINISHES

BODY BRASS
 PLATED GOLD
 CENTER CONTACT BERYLLIUM COPPER
 PLATED GOLD
 INSULATOR TEFLON

ES-73599-0000-016	INTERFACE
SPECIFICATION	DESCRIPTION

73415-1002	P/N 73415-1001, ONE PER BAG
73415-1001	PER COMMERCIAL REQUIREMENTS, BULK
73415-1000	PER MILITARY REQUIREMENTS, BULK
PART NUMBER	PLATING AND PACKAGING

CHG: ADDED P/N 73415-1002 EC NO. URF2007-0264 DRWN: FLAHERTY 2007/07/09 CHKD: SSPAR 2007/07/09 APPR: JMWENER 2007/07/09 D1	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED) 4 PLACES ± .005 3 PLACES ± .004 2 PLACES ± .003 1 PLACE ± .002 ANGULAR ± 2°	DIMENSION STYLE MM/IN	SCALE DESIGN UNITS METRIC	THIRD ANGLE PROJECTION TITLE MMCX JACK, R/A, PCB 50 OHMS MMCX-J/PCB MOLEX INCORPORATED		
		DRAWN BY JM 2005/07/22	CHECKED BY JM 2005/07/22	APPROVED BY JMW 2005/07/22		MATERIAL NO. SEE TABLE	DOCUMENT NO. SD-73415-100
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				SIZE C	SHEET NO. 1 OF 1
		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

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